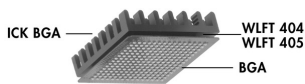


Data sheet Product ICK BGA 19 x 19 x 14

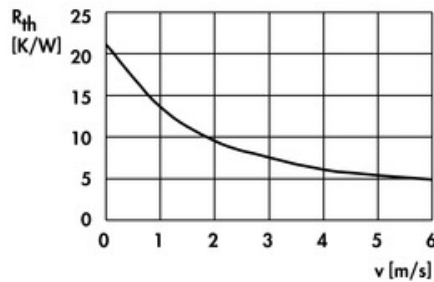
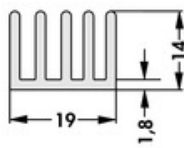
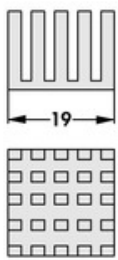


Heatsinks and active heatsinks for processors > Heatsinks for BGAs
19 x 19 x 14 mm, for IC design BGA and others

Features

| | |
|------------------------------|---|
| way of fixation: | <ul style="list-style-type: none"> • therm. conductive foil • therm. cond. adhesive |
| socket: | universal |
| suitable for processor type: | universal |
| width: | 19 mm |
| height: | 14 mm |
| plate thickness: | 1.8 mm |
| length: | 19 mm |
| thermal resistance: | 21 - 5 K/W |
| dissipation loss: | 2.8 W |
| surface: | black anodised |

Technical Drawing



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